Dell EMC PowerEdge R740 and R740xd

Technical Guide



Notes, cautions, and warnings

(i) NOTE: A NOTE indicates important information that helps you make better use of your product.

CAUTION: A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

WARNING: A WARNING indicates a potential for property damage, personal injury, or death.

© 2017- 2022 Dell Inc. or its subsidiaries. All rights reserved. Dell Technologies, Dell, and other trademarks are trademarks of Dell Inc. or its subsidiaries. Other trademarks may be trademarks of their respective owners.

Contents

Chapter 1: Product overview	
Introduction	5
New technologies	5
Chapter 2: System features	
System features comparison	
Product specifications	
Chapter 3: Chassis views and features	
R740 and R740xd front views	
R740 and R740xd Rear views	
Internal view of the system	
Chapter 4: Processors	
Supported Processors	
Chipset	
Chapter 5: Memory	
Chapter 6: Storage	
Supported drives	
Storage controllers	
Optical Drives	
Tape Drives	
IDSDM with vFlash card	
Chapter 7: Networking and PCIe	
Chapter 8: Supported operating system	
Chapter 9: Power, thermal and acoustics	
Power	
Thermal	
Acoustics	
Chapter 10: Rack rails	42
Chapter 11: Dell EMC OpenManage systems management	
Server and Chassis Managers	
Dell EMC consoles	
Automation Enablers	
Integration with third-party consoles	
Connections for third-party consoles	

Dell EMC Update Utilities	
Dell resources	45
	47
Chapter 12: Appendix A. Additional specifications	
Chassis dimensions	
Chassis weight	
USB peripherals Environmental specifications	
Environmental specifications	
Chapter 13: Appendix B. Standards compliance	
Chapter 14: Appendix C Additional resources	
Chapter 15: Appendix D. Support and deployment services	
Dell EMC ProDeploy Enterprise Suite	
Dell EMC ProDeploy Plus	
Dell EMC ProDeploy	
Dell EMC Basic Deployment	
Dell EMC Residency Services	53
Deployment services	
Dell EMC Remote Consulting Services	
Dell EMC Data Migration Service	
ProSupport Enterprise Suite	
ProSupport Plus	
ProSupport	
ProSupport One for Data Center	
Support Technologies	
Additional professional services	
Dell Education Services	
Dell EMC Global Infrastructure Consulting Services	
Dell EMC Managed Services	

Product overview

Topics:

- Introduction
- New technologies

Introduction

The Dell EMC PowerEdge R740 and R740xd are two socket, 2U rack servers designed to run complex workloads using highly scalable memory, I/O capacity and network options. The R740 and R740xd features the 2nd Generation Intel® Xeon® Scalable processor family, up to 24 DIMMs, PCI Express® (PCIe) 3.0 enabled expansion slots, and a choice of network interface technologies to cover NIC and rNDC.

The PowerEdge R740 is a general-purpose platform capable of handling demanding workloads and applications, such as data warehouses, e-commerce, databases, and high-performance computing (HPC).

The PowerEdge R740xd adds extraordinary storage capacity options, making it well-suited for data- intensive applications that require greater storage, while not sacrificing I/O performance.

New technologies

Table 1. New technologies in R740 and R740xd

New technology	Detailed description
2nd Generation Intel® Xeon® Processor Scalable family	The 2nd Generation Intel® Xeon® Scalable processor family has advanced features that deliver exceptional performance and value. See the Processors section.
Intel C620 series chipset	Intel® Platform Controller Hub (PCH)
2933 MT/s DDR4 memory	The 2nd Generation Intel® Xeon® Scalable processor family supports up to 2933 MT/s memory. The R740 and R740xd supports two DIMMs per channel at 2933 MT/s with select processors. See the Memory section for details.
Intel® Optane™ DC persistent memory	 Up to 6 per CPU socket. Max 12 for 2S configuration. 256GB, 512GB per DIMM 1866, 2133, 2400, 2666 MT/s Up to 6.14TB max, (7.68TB max with DCPMM and LDRIMM)
iDRAC 9 with Lifecycle Controller	The new embedded system management solution features hardware and firmware inventory and alerting, in-depth memory alerting, faster performance, a dedicated gigabit port and many more features. See the iDRAC section.
Wireless management	The Quick Sync 2.0 will offer feature parity with the previous server generation NFC interface and improved user experience. To extend this Quick Sync feature to wide variety of Mobile OS's with higher data throughput, the Quick Sync 2.0 version replaces the previous server generation NFC technology with wireless at-the-box system management.

System features

Compared to the previous generation of Dell EMC PowerEdge servers, the R740 and R740xd have more drive bay options, more PCIe slots, next-generation RAID controllers and advanced system management.

Topics:

- System features comparison
- Product specifications

System features comparison

Table 2. Comparison of PowerEdge R740/R740xd and R730/R730xd

Feature	PowerEdge R740/R740xd	PowerEdge R730/R730xd
CPU	2 x 2nd Generation Intel® Xeon® Scalable processor family	Intel® Xeon® processor E5-2600 product family
Intel Ultra Path Interconnect (UPI)	Intel® Ultra Path Interconnect (UPI)	Intel® QuickPath Interconnect (QPI)
Memory	 24 x DDR4 RDIMM, LRDIMM 12 x NVDIMM 12 x DCPMM (Intel® Optane[™] DC persistent memory) 	24 x DDR4 RDIMM, LRDIMM
Disk drives	 3.5 -inch or 2.5 -inch 12Gb/s SAS, 6Gb/s SATA Up to 24 x NVMe 	 3.5 -inch, 2.5 -inch or 1.8 -inch 12Gb/s SAS, 6Gb/s SATA 4 x PCle SSD with common slot
Storage controllers	Adapters: HBA330, HBA350i, H330(R740 only), H350(R740 only), H730P, H740P, H840, 12G SAS HBA, HBA355e, H750 Mini Mono: HBA330, H330(R740 only), H730P, H740P, H350 (R740 only), HBA350i (R740xd only) SW RAID: S140	Adapters: HBA330, H330, H730, H730P, H830 (ext) Mini Mono: HBA330, H330, H730, H730P SW RAID: S130
PCIe slots	Max 8 x PCle 3.0	Max 7 x PCle 3.0 or 6 x PCle 3.0
rNDC	4x 1GbE, 4x 10GbE, 2x 10GbE + 2x 1GbE, or 2x 25GbE	4x 1GbE, 4x 10GbE, or 2x 10GbE + 2x 1GbE
USB ports	Front: 1 x Dedicated iDRAC direct USB 2 x USB 2.0 1 x USB 3.0 (optional only for R740) 1 x Video Rear: 1 x Dedicated iDRAC network port 1 x Serial 2 x USB 3.0 1 x Video	Front: two ports (USB 2.0), one managed port Rear: two ports (USB 3.0) Internal: one port (USB 3.0)

Feature	PowerEdge R740/R740xd	PowerEdge R730/R730xd
Rack height	2U	20
Power supply	 AC (Platinum): 495W, 750W, 1100W, 1600W, 2000W, 2400W AC (Titanium): 750W, 1600W, 2600W DC: 1100W DC: 750 W Mixed Mode Platinum (for China only) AC: 750 W Mixed Mode Platinum Mixed mode/HVDC: 750W, 1100W 	 AC: 495W, 750W, 1100W DC: 750W, 1100W
System management	Lifecycle Controller 3.x, OpenManage, QuickSync2.0, OMPC3, Digital License Key, iDRAC Direct(dedicated micro-USB port), Easy Restore, vFlash	Lifecycle Controller 3.x, OpenManage, QuickSync1.0, PM3, Digital License Key, iDRAC8, iDRAC Direct(dedicated micro-USB port), Easy Restore, vFlash
Internal GPU	 *3 x 300W (double-width) or 6 x 150W (single-width) NOTE: *Only supports up to 2 x NVIDIA M10 GPUs. 	 2 x 300W (double-wide) or 4 x 150W (single-wide) Not supported on R730xd FPGAs not supported on the R730/xd.
Availability	 Hot-plug drives Hot-plug redundant cooling Hot-plug redundant power supplies IDSDM support Boot Optimized Storage Subsystem (BOSS) 	 Hot-plug drives Hot-plug redundant cooling Hot-plug redundant power supplies IDSDM support

Product specifications

Table 3. R740 product specifications

Features	Technical Specification
Processor	 Up to two 2nd Generation Intel® Xeon® Scalable processors Up to 28 cores per processor
Memory	 24 DDR4 DIMM slots Supports RDIMM /LRDIMM, 3TB max Speeds up to 2933MT/s Up to 12 NVDIMM, 192 GB Max Up to 12 Intel® Optane™ DC persistent memory DCPMM, 6.14TB max, (7.68TB max with DPCMM + LRDIMM)
Storage controllers	Internal controllers: PERC H330 PERC H350 PERC H730P PERC H740P Software RAID (SWRAID) S140 H750 HBA350i Boot Optimized Storage Subsystem: HW RAID 2 x M.2 SSDs 240GB or 480GB External PERC (RAID): PERC H840

Table 3. R740 product specifications (continued)

Features	Technical Specification
	• HBA355e
	12Gbps SAS HBAs (non-RAID):
	• External - 12Gbps SAS HBA (non-RAID)
	Internal- HBA330 (non-RAID)
Drive bays	Front drive bays: Up to 16 x 2.5" SAS/SATA (HDD/SSD) max 122.88TB or up to 8 x 3.5" SAS/ SATA HDD max 128TB Optional DVD-ROM, DVD+RW
Power supplies	 Titanium 750W, 1600W, and 2600W Platinum 495W, 750W, 750W Mixed Mode HVDC (for China only), 750 W Mixed Mode 240 V DC (For china only),1100W, 1600W, 2000W, and 2400W 1100W 380VDC (China and Japan only) Gold 1100W -48VDC Hot plug power supplies with full redundancy. Up to 6 hot plugs fans with full redundancy
Dimensions	 Form factor: Rack (2U) Height: 86.8mm (3.4") Width: 434.0mm (17.08") Depth: 737.5mm (29.03") Weight: 28.6kg (63lbs.) (i) NOTE: Dimensions do not include bezel
Embedded management	iDRAC9, iDRAC RESTful with Redfish, iDRAC Direct, Quick Sync 2 wireless module optional
Bezel	Optional LCD Bezel or Security bezel
OpenManage™ Software	 OpenManage Enterprise OpenManage Mobile OpenManage Power Center
Integrations and connections	Integrations: • Microsoft® System Center • VMware® vCenter™ • BMC Truesight • Red Hat Ansible Connections: • Nagios Core & Nagios XI • Micro Focus Operations Manager i (OMi) • IBM Tivoli Netcool/OMNIbus • IBM Tivoli® Network Manager IP Edition
Security	 TPM 1.2/2.0, optional TCM 2.0 Cryptographically signed firmware Secure Boot System Lockdown (requires OpenManage Enterprise) Secure erase
I/O & Ports	Network daughter card options • 4 x 1GbE • 2 x 10GbE + 2 x 1GbE • 4 x 10GbE • 2 x 25GbE Front ports: • Video • 2 x USB 2.0

Table 3. R740 product specifications (continued)

Features	Technical Specification
	 1 x USB 3.0 (optional) 1 x Dedicated iDRAC Direct Micro-USB
	Rear ports:
	 Video, serial 2 x USB 3.0 1 x Dedicated iDRAC network port
	Video card: VGA
	Riser options with up to 8 PCIe Gen 3 slots, maximum of 4 x 16 slots
Accelerator options	Up to three 300W or six 150W GPUs, or up to three double-width or four single-width FPGAs.
Supported operating systems	 Canonical® Ubuntu® LTS Citrix® Hypervisor Oracle® Linux Microsoft Windows Server® LTSC with Hyper-V Red Hat® Enterprise Linux SUSE® Linux Enterprise Server VMware® ESXi For specifications and interoperability details, see dell.com/OSsupport
Recommended support	Dell ProSupport Plus for critical systems or Dell ProSupport for premium hardware and software support for your PowerEdge solution. Consulting and deployment offerings are also available.

R740xd product specifications

The following table shows the technical specifications for the PowerEdge R740xd:

Table 4. R740xd product specifications

Features	Technical Specifications
Processor	 Up to two 2nd Generation Intel® Xeon® Scalable processors Up to 28 cores per processor
Memory	 24 DDR4 DIMM slots Supports RDIMM /LRDIMM, up to 3TB Speeds up to 2933 MT/s Up to 12 NVDIMM, 192 GB Max Up to 12 Intel® Optane[™] DC persistent memory DCPMM, 6.14TB max, (7.68TB max with DPCMM + LRDIMM)
Storage controllers	Internal controllers: • PERC H730P • H750 • HBA350i • PERC H740P • Software RAID (SWRAID) S140 Boot Optimized
	Boot Optimized Storage Subsystem:
	• HW RAID 2 x M.2 SSDs 240 GB or 480 GB
	External PERC (RAID):
	 PERC H840 HBA355e

Table 4. R740xd product specifications (continued)

Features	Technical Specifications
	12Gbps SAS HBAs (non-RAID):
	External - 12Gbps SAS HBA (non-RAID)
	Internal - HBA330 (non-RAID)
Drive bays	Front bays:
	Up to 24 x 2.5" SAS/SSD/NVMe, max 184TB
	Up to 12 x 3.5" SAS/SATA HDD max 192TB Mid bay:
	 up to 4 x 2.5" SAS/SSD, max 30.72TB
	 Up to 4 x 3.5" max 64TB
	Rear bays:
	• Up to 4 x 2.5" SAS/SSD/, max 30.72TB
	Up to 2 x 3.5" max 32TB SAS/SATA HDD
Power supplies	 Titanium 750W Platinum 495W, 750W, 750W Mixed Mode HVDC (for China only), 750W Mixed Mode 240 V DC (For China only),1100W, 1600W, 2000W, and 2400W 1100W 380VDC (China and Japan only) Gold 1100W -48VDC
	Hot plug power supplies with full redundancy
	Up to 6 hot plugs fans with full redundancy
Dimensions	 Form factor: Rack (2U) Height: 86.8m (3.4") Width*: 434mm (17.1") Depth*: 737.5mm (29.0") Weight: 33.1kg (73.0lbs.) (i) NOTE: * Dimensions do not include bezel.
Embedded management	• iDRAC9
	 Quick Sync 2 wireless module optional iDRAC RESTful with Redfish
	 iDRAC RESTILITION Redistri iDRAC Direct
Bezel	Optional LCD Bezel or Security bezel
OpenManage™ Software	OpenManage Enterprise
	OpenManage Mobile
	OpenManage Power Center
Integrations and connections	Integrations: • Microsoft® System Center • VMware® vCenter™ • BMC Truesight • Red Hat Ansible
	Connections:
	Nagios Core & Nagios XI Mirro Focus Operations Manager i (OMi)
	 Micro Focus Operations Manager i (OMi) IBM Tivoli Netcool/OMNIbus
	IBM Tivoli® Network Manager IP Edition
Security	• TPM 1.2/2.0, TCM 2.0 optional
	Cryptographically signed firmwareSecure Boot

Features	Technical Specifications
	System Lockdown (requires OpenManage Enterprise)Secure erase
I/O & Ports	Network daughter card options: 4 x 1GbE or 2 x 10GbE + 2 x 1GbE or 4 x 10GbE or 2 x 25GbE Front ports: VGA 2 x USB 2.0 1 x USB 3.0 (optional) 1 x Dedicated iDRAC direct USB Rear ports: VGA 2 x USB 3.0 1 x Dedicated iDRAC network port
	 Video card: VGA Riser options with p to 8 PCIe Gen 3 slots, maximum of 4 x 16 slots
Accelerator options	 Up to three 300W or six 150W GPUs or Up to three double-width or four single-width FPGAs. GPU and FPGA options are available only on 24 x 2.5 -inch drive chassis. Up to two GPUs are supported on NVMe configurations.
Supported operating systems	 Canonical® Ubuntu® LTS Citrix® Hypervisor Microsoft® Windows Server® LTSC with Hyper-V Oracle® Linux Red Hat® Enterprise Linux SUSE® Linux Enterprise Server VMware® ESXi®
Recommended support	Dell ProSupport Plus for critical systems or Dell ProSupport for premium hardware and software support for your PowerEdge solution. Consulting and deployment offerings are also available.

Table 4. R740xd product specifications (continued)

Chassis views and features

Topics:

- R740 and R740xd front views
- R740 and R740xd Rear views
- Internal view of the system

R740 and R740xd front views

The R740 supports up to 16 x 2.5 -inch or up to 8 x 3.5 -inch front-accessible, hot-plug hard drives that are secured by a removable front bezel.

R740 Front view - 8 x 2.5 -inch hard drive configuration



R740 Front view - 16 x 2.5 -inch hard drive configuration



R740 Front view - 8 x 3.5 -inch hard drive configuration



R740xd

The R740xd supports up to 12x 3.5 -inch or up to 24×2.5 -inch front-accessible, hot-plug hard drives that are secured by a removable front bezel.

R740xd Front view - 12 x 3.5 -inch hard drive configuration



R740xd Front view - 24 x 2.5 -inch hard drive configuration



R740 and R740xd Rear views

The R740 back panel includes PSUs, Ethernet connectors, PCIe slots and many other features described in this guide R740 Rear view - with 8x PCIe slots available



R740 Rear view - with 4x PCle slots available with riser 2 and riser 3 blanks



R740xd

R740xd Rear view - with 2 x 3.5 -inch backplane installed



R740xd Rear view - with 4 x 2.5 -inch backplane installed



Internal view of the system



Figure 1. R740 internal chassis view

- 1. hard drive backplane
- 3. cooling fan in the cooling fan assembly (6)
- 5. CPU2 processor heat sink module socket
- 7. network daughter card
- 9. system board
- 11. integrated storage controller card

- 2. SAS expander card
- 4. memory module
- 6. expansion card riser 3
- 8. expansion card riser 2
- 10. expansion card riser 1
- 12. CPU1 processor heat sink module



Figure 2. R740 internal chassis view – NVDIMM-N battery

- 1. hard drive backplane
- 3. cooling fan (6) in the cooling fan assembly
- 5. expansion card riser 3
- 7. expansion card riser 2
- 9. expansion card riser 1
- 11. NVDIMM-N battery

- 2. SAS expander card
- 4. air shroud
- 6. network daughter card
- 8. system board
- 10. integrated storage controller card

R740xd



Figure 3. R740xd internal chassis view – hard drive tray and hard drive cage with NVDIMM-N battery

- 1. hard drive backplane
- 3. cooling fan (6) in the cooling fan assembly
- 5. mid hard drive backplane
- 7. hard drive (2 or 4) in the hard drive cage
- 9. expansion card riser 1
- 11. NVDIMM-N battery

- 2. SAS expander card
- 4. hard drive (4) in the hard drive tray
- 6. rear hard drive backplane
- 8. system board
- 10. integrated storage controller card



Figure 4. R740xd internal chassis view with NVDIMM-N battery on the air shroud

- 1. hard drive backplane
- 3. cooling fan (6) in the cooling fan assembly
- 5. expansion card riser 3
- 7. expansion card riser 2
- 9. expansion card riser 1
- 11. NVDIMM-N battery

- 2. SAS expander card
- 4. air shroud
- 6. network daughter card
- 8. system board
- 10. integrated storage controller card

For additional system views, see the Dell EMC PowerEdge R740 and R740xd installation and service manual on Dell.com/ Support/Manuals

Processors

The 2nd Generation Intel® Xeon® Scalable processor family provides the foundation for a powerful datacenter platform. The key features are as follows:

- Higher Per-Core Performance: Up to 28 cores, delivery high performance and scalability for compute-intensive workloads across compute, storage & network usages. 2nd Generation Intel® Xeon® Processors can offer even greater core or frequencies, or both.
- Large Memory Bandwidth/Capacity: 6 memory channels and up to 6 DCPMMs per socket of Intel® Optane™ DC persistent memory for data-centric workloads on select processors
- Al capability: Intel® Deep Learning Boost drives inferencing for vector neural networks right in your CPU
- Expanded I/O: 48 lanes of PCle 3.0 bandwidth and throughput for demanding I/O-intensive workloads.
- Intel Ultra Path Interconnect (UPI): Up to three Intel UPI channels increase scalability of the platform to as many as eight sockets, as well as improves inter-CPU bandwidth for I/O intensive workloads.
- Intel Advanced Vector Extensions 512 (Intel AVX-512) with a single AVX512 fused multiply add (FMA) execution units. SKUs which support Advanced RAS enable a 2nd FMA execution unit.
- Security without Compromise: Near-zero encryption overhead enables higher performance on all secure data transactions with enhanced hardware mitigation.

Topics:

- Supported Processors
- Chipset

Supported Processors

Table 5. Supported Processors for R740

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Intel Xeon Processo r Scalable Family	8280L	Platinum	ХСС	2.7	38.5	NA	2933	28	Turbo	205W
Intel Xeon Processo r Scalable Family	8280M	Platinum	хсс	2.7	38.5	NA	2933	28	Turbo	205W
Intel Xeon Processo r Scalable Family	8280	Platinum	xcc	2.7	38.5	NA	2933	28	Turbo	205W
Intel Xeon Processo r Scalable Family	8276L	Platinum	xcc	2.2	NA	NA	2933	28	Turbo	165W
Intel Xeon	8276M	Platinum	XCC	2.2	NA	NA	2933	28	Turbo	165W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Processo r Scalable Family										
Intel Xeon Processo r Scalable Family	8276	Platinum	xcc	2.2	NA	NA	2933	28	Turbo	165W
Intel Xeon Processo r Scalable Family	8270	Platinum	XCC	2.7	NA	NA	2933	26	Turbo	205W
Intel Xeon Processo r Scalable Family	8268	Platinum	xcc	2.9	NA	NA	2933	24	Turbo	205W
Intel Xeon Processo r Scalable Family	8260L	Platinum	XCC	2.4	NA	NA	2933	24	Turbo	165W
Intel Xeon Processo r Scalable Family	8260M	Platinum	xcc	2.4	NA	NA	2933	24	Turbo	165W
Intel Xeon Processo r Scalable Family	8260Y	Platinum	XCC	2.4	NA	NA	2933	24/20/16	Turbo	165W
Intel Xeon Processo r Scalable Family	8260	Platinum	xcc	2.4	NA	NA	2933	24	Turbo	165W
Intel Xeon Processo r Scalable Family	8253	Platinum	xcc	2.2	NA	NA	2933	16	Turbo	125W
Intel Xeon Processo r Scalable Family	8180M	Platinum	xcc	2.5	38.5	10.4	2667	28	Turbo	205W
Intel Xeon Processo	8180	Platinum	XCC	2.5	38.5	10.4	2667	28	Turbo	205W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
r Scalable Family										
Intel Xeon Processo r Scalable Family	8176M	Platinum	xcc	2.1	38	10.4	2667	28	Turbo	165W
Intel Xeon Processo r Scalable Family	8176	Platinum	хсс	2.1	38	10.4	2667	28	Turbo	165W
Intel Xeon Processo r Scalable Family	8170M	Platinum	xcc	2.1	36	10.4	2667	26	Turbo	165W
Intel Xeon Processo r Scalable Family	8170	Platinum	xcc	2.1	36	10.4	2667	26	Turbo	165W
Intel Xeon Processo r Scalable Family	8168	Platinum	XCC	2.7	33	10.4	2667	24	Turbo	205W
Intel Xeon Processo r Scalable Family	8164	Platinum	хсс	2.7	33	10.4	2667	26	Turbo	205W
Intel Xeon Processo r Scalable Family	8160M	Platinum	xcc	2.1	33	10.4	2667	24	Turbo	150W
Intel Xeon Processo r Scalable Family	8160	Platinum	хсс	2.1	33	10.4	2667	24	Turbo	150W
Intel Xeon Processo r Scalable Family	8158	Platinum	xcc	3	24.75	10.4	2667	12	Turbo	150W
Intel Xeon Processo r Scalable Family	8156	Platinum	xcc	3.6	16.5	10.4	2667	4	Turbo	105W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Intel Xeon Processo r Scalable Family	8153	Platinum	хсс	2.0	22	10.4	2667	16	Turbo	125W
Intel Xeon Processo r Scalable Family	6262V	Platinum	XCC	1.9	33	NA	2400	24	Turbo	135W
Intel Xeon Processo r Scalable Family	6258R	Gold	хсс	2.7	38.5	10.4	2933	28	Turbo	205W
Intel Xeon Processo r Scalable Family	6256	Gold	хсс	3.6	33	10.4	2933	NA	Turbo	NA
Intel Xeon Processo r Scalable Family	6254	Gold	xcc	3.1	NA	NA	2933	18	Turbo	200W
Intel Xeon Processo r Scalable Family	6252	Gold	хсс	2.1	NA	NA	2933	24	Turbo	150W
Intel Xeon Processo r Scalable Family	6252N	Gold	хсс	3.0	35.75	NA	2933	24	Turbo	150W
Intel Xeon Processo r Scalable Family	6250	Gold	хсс	3.9	35.75	10.4	2933	NA	Turbo	NA
Intel Xeon Processo r Scalable Family	6248R	Gold	xcc	3.0	35.75	10.4	2933	24	Turbo	205W
Intel Xeon Processo r Scalable Family	6248	Gold	хсс	2.5	NA	NA	2933	20	Turbo	150W
Intel Xeon	6246R	Gold	XCC	3.4	22	10.4	2933	16	Turbo	205W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Processo r Scalable Family										
Intel Xeon Processo r Scalable Family	6246	Gold	XCC	3.3	24.75	NA	2933	12	Turbo	165W
Intel Xeon Processo r Scalable Family	6244	Gold	XCC	3.6	NA	NA	2933	8	Turbo	150W
Intel Xeon Processo r Scalable Family	6242R	Gold	XCC	3.1	27.5	10.4	2933	20	Turbo	205W
Intel Xeon Processo r Scalable Family	6242	Gold	XCC	2.8	NA	NA	2933	16	Turbo	150W
Intel Xeon Processo r Scalable Family	6240	Gold	XCC	2.6	NA	NA	2933	24	Turbo	165W
Intel Xeon Processo r Scalable Family	6240L	Gold	XCC	2.6	24.75	NA	2933	18	Turbo	150W
Intel Xeon Processo r Scalable Family	6240M	Gold	XCC	2.6	24.75	NA	2933	18	Turbo	150W
Intel Xeon Processo r Scalable Family	6240Y	Gold	XCC	2.6	NA	NA	2933	18/14/8	Turbo	150W
Intel Xeon Processo r Scalable Family	6240R	Gold	XCC	2.4	35.75	10.4	2933	24	Turbo	165W
Intel Xeon Processo	6238	Gold	XCC	2.1	30.25	NA	2933	22	Turbo	140W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
r Scalable Family										
Intel Xeon Processo r Scalable Family	6238L	Gold	XCC	2.1	30.25	NA	2933	22	Turbo	140W
Intel Xeon Processo r Scalable Family	6238M	Gold	XCC	2.1	30.25	NA	2933	22	Turbo	140W
Intel Xeon Processo r Scalable Family	6238R	Gold	XCC	2.2	38.5	10.4	2933	28	Turbo	165W
Intel Xeon Processo r Scalable Family	6234	Gold	XCC	3.3	24.75	NA	2933	8	Turbo	130W
Intel Xeon Processo r Scalable Family	6230R	Gold	XCC	2.1	35.75	10.4	2933	26	Turbo	150W
Intel Xeon Processo r Scalable Family	6230N	Gold	XCC	2.3	27.5	NA	2933	20	Turbo	125W
Intel Xeon Processo r Scalable Family	6230	Gold	XCC	2.1	NA	NA	2933	20	Turbo	125W
Intel Xeon Processo r Scalable Family	6226R	Gold	XCC	2.9	22	10.4	2933	16	Turbo	150W
Intel Xeon Processo r Scalable Family	6226	Gold	XCC	2.7	19.25	NA	2933	12	Turbo	125W
Intel Xeon Processo r Scalable Family	6222V	Gold	XCC	1.8	27.5	NA	2400	20	Turbo	115W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Intel Xeon Processo r Scalable Family	6212U	Gold	XCC	2.4	NA	NA	2933	24	Turbo	165W
Intel Xeon Processo r Scalable Family	6210U	Gold	XCC	2.5	NA	NA	2933	20	Turbo	150W
Intel Xeon Processo r Scalable Family	6209U	Gold	XCC	2.1	27.5	NA	2933	20	Turbo	125W
Intel Xeon Processo r Scalable Family	6208U	Gold	XCC	2.9	22	NA	2933	16	Turbo	150W
Intel Xeon Processo r Scalable Family	6154	Gold	XCC	3.0	25	10.4	2667	18	Turbo	200W
Intel Xeon Processo r Scalable Family	6152	Gold	XCC	2.1	25	10.4	2667	22	Turbo	140W
Intel Xeon Processo r Scalable Family	6150	Gold	XCC	2.7	25	10.4	2667	18	Turbo	165W
Intel Xeon Processo r Scalable Family	6148	Gold	XCC	2.4	27	10.4	2667	20	Turbo	150W
Intel Xeon Processo r Scalable Family	6146	Gold	XCC	3.2	24.75	10.4	2667	12	Turbo	165W
Intel Xeon Processo r Scalable Family	6144	Gold	XCC	3.5	24.75	10.4	2667	8	Turbo	150W
Intel Xeon	6142M	Gold	ХСС	2.6	22	10.4	2667	16	Turbo	150W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Processo r Scalable Family										
Intel Xeon Processo r Scalable Family	6142	Gold	XCC	2.6	22	10.4	2667	16	Turbo	150W
Intel Xeon Processo r Scalable Family	6140M	Gold	XCC	2.3	25	10.4	2667	18	Turbo	140W
Intel Xeon Processo r Scalable Family	6140	Gold	XCC	2.3	25	10.4	2667	18	Turbo	140W
Intel Xeon Processo r Scalable Family	6138	Gold	XCC	2	27.5	10.4	2667	20	Turbo	125W
Intel Xeon Processo r Scalable Family	6136	Gold	XCC	3.0	24.75	10.4	2667	12	Turbo	125W
Intel Xeon Processo r Scalable Family	6134M	Gold	XCC	3.2	24.75	10.4	2667	8	Turbo	130W
Intel Xeon Processo r Scalable Family	6134	Gold	XCC	3.3	24.75	10.4	2667	8	Turbo	130W
Intel Xeon Processo r Scalable Family	6132	Gold	XCC	2.6	19.25	10.4	2667	14	Turbo	140W
Intel Xeon Processo r Scalable Family	6130	Gold	XCC	2.1	22	10.4	2667	16	Turbo	125W
Intel Xeon Processo	6128	Gold	XCC	3.4	19.25	10.4	2667	6	Turbo	115W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
r Scalable Family										
Intel Xeon Processo r Scalable Family	6126	Gold	XCC	2.6	19.25	10.4	2667	12	Turbo	125W
Intel Xeon Processo r Scalable Family	5222	Gold	XCC	3.8	NA	NA	2933	4	Turbo	105W
Intel Xeon Processo r Scalable Family	5220	Gold	XCC	2.2	NA	NA	2667	18	Turbo	125W
Intel Xeon Processo r Scalable Family	5220S	Gold	XCC	2.7	24.75	NA	2667	18	Turbo	125W
Intel Xeon Processo r Scalable Family	5220R	Gold	XCC	2.2	35.75	10.4	2933	24	Turbo	150W
Intel Xeon Processo r Scalable Family	5218	Gold	XCC	2.3	22	NA	2667	20	Turbo	125W
Intel Xeon Processo r Scalable Family	5218N	Gold	HCC	2.3	22	NA	2667	16	Turbo	110W
Intel Xeon Processo r Scalable Family	5218R	Gold	XCC	2.1	27.5	10.4	2667	20	Turbo	125W
Intel Xeon Processo r Scalable Family	5217	Gold	HCC	3.0	NA	NA	2667	8	Turbo	125W
Intel Xeon Processo r Scalable Family	5215	Gold	HCC	2.5	NA	NA	2667	10	Turbo	85W

Model	Intel	SKU	Steppin	Speed(GH	Cache(QPI(GT/	Max	Cores	Turbo	TDP
	SKU	type	g	z)	MB)	s)	Memory Speed(MT/s)			
Intel Xeon Processo r Scalable Family	5215M	Gold	HCC	2.5	NA	NA	2667	10	Turbo	85W
Intel Xeon Processo r Scalable Family	5215L	Gold	НСС	2.5	NA	NA	2667	10	Turbo	85W
Intel Xeon Processo r Scalable Family	5122	Gold	XCC	3.6	16.5	10.4	2400	4	Turbo	105W
Intel Xeon Processo r Scalable Family	5120	Gold	HCC	2.2	19.25	10.4	2400	14	Turbo	105W
Intel Xeon Processo r Scalable Family	5118	Gold	HCC	2.3	16.5	10.4	2400	12	Turbo	105W
Intel Xeon Processo r Scalable Family	5115	Gold	HCC	2.4	13.75	10.4	2400	10	Turbo	85W
Intel Xeon Processo r Scalable Family	4216	Silver	HCC	2.1	NA	NA	2667	16	Turbo	100W
Intel Xeon Processo r Scalable Family	4215R	Silver	HCC	3.2	11	9.6	2400	8	Turbo	130W
Intel Xeon Processo r Scalable Family	4215	Silver	HCC	2.5	NA	NA	2667	8	Turbo	85W
Intel Xeon Processo r Scalable Family	4214	Silver	HCC	2.2	NA	NA	2667	12	Turbo	85W
Intel Xeon	4214Y	Silver	НСС	2.2	NA	NA	2667	12/10/8	Turbo	105W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
Processo r Scalable Family										
Intel Xeon Processo r Scalable Family	4214R	Silver	HCC	2.4	16.5	9.6	2400	12	Turbo	100W
Intel Xeon Processo r Scalable Family	4210R	Silver	HCC	2.4	13.75	9.6	2400	10	Turbo	100W
Intel Xeon Processo r Scalable Family	4210	Silver	LCC	2.2	NA	NA	2667	10	Turbo	85W
Intel Xeon Processo r Scalable Family	4208	Silver	LCC	2.1	NA	NA	2667	8	Turbo	85W
Intel Xeon Processo r Scalable Family	4116	Silver	HCC	2.1	16	9.6	2400	12	Turbo	85W
Intel Xeon Processo r Scalable Family	4114	Silver	LCC	2.2	14	9.6	2400	10	Turbo	85W
Intel Xeon Processo r Scalable Family	4112	Silver	LCC	2.6	8.25	9.6	2400	4	Turbo	85W
Intel Xeon Processo r Scalable Family	4110	Silver	LCC	2.1	11	9.6	2400	8	Turbo	85W
Intel Xeon Processo r Scalable Family	4108	Silver	LCC	1.8	11	9.6	2400	8	Turbo	85W
Intel Xeon Processo	3206R	Bronze	LCC	1.9	11	9.6	2400	8	No Turbo	85W

Model	Intel SKU	SKU type	Steppin g	Speed(GH z)	Cache(MB)	QPI(GT/ s)	Max Memory Speed(MT/s)	Cores	Turbo	TDP
r Scalable Family										
Intel Xeon Processo r Scalable Family	3204	Bronze	LCC	1.9	NA	NA	2667	6	No Turbo	85W
Intel Xeon Processo r Scalable Family	3106	Bronze	LCC	1.7	11	9.6	2133	8	No Turbo	85W
Intel Xeon Processo r Scalable Family	3104	Bronze	LCC	1.7	11	9.6	2133	6	No Turbo	85W

Supported Processors for R740

(i) NOTE: For more information on Intel Xeon Scalable Processor Family, see www.intel.com

Processor Configurations

The R740 supports two processors with up to 28 cores per processor.

Single CPU Configuration

The R740 will function normally if there is just a single processor placed in the CPU1 socket . However, CPU and memory blanks associated with CPU2 are required to be populated for thermal reasons. The system will not boot if only CPU2 socket is populated. With single CPU configuration, any Riser1 (1A/1B/1D) card and only Riser 2B will be functional.

Processor Installation

For processor installation instructions see the Dell PowerEdge R740 Installation and Service Manuals.

Chipset

The Dell EMC PowerEdge R740 and R740xd use the Intel C620 chipset (PCH) that provides extensive I/O support. Functions and capabilities include:

- ACPI Power Management Logic Support, Revision 4.0a
- PCI Express Base Specification Revision 3.0
- Integrated Serial ATA host controller, supports data transfer rates of up to 6 Gb/s on all ports.
- xHCI USB controller with SuperSpeed USB 3.0 ports
- Direct Media Interface
- Serial Peripheral Interface
- Enhanced Serial Peripheral Interface

- Flexible I/O Allows some high speed I/O signals to be configured as PCIe root ports, PCIe uplink for use with certain PCH SKUs, SATA (and sSATA), or USB 3.0.
- General Purpose Input Output (GPIO)
- Low Pin Count interface, interrupt controller, and timer functions
- System Management Bus Specification, Version 2.0
- Integrated Clock Controller / Real Time Clock Controller
- Intel High Definition Audio and Intel Smart Sound Technology
- Integrated 10/1 Gb Ethernet
- Integrated 10/100/1000 Mbps Ethernet MAC
- Supports Intel Rapid Storage Technology Enterprise
- Supports Intel Active Management Technology and Server Platform Services
- Supports Intel Virtualization Technology for Directed I/O
- Supports Intel Trusted Execution Technology
- JTAG Boundary Scan support
- Intel Trace Hub for debug

For more information, visit Intel.com

Each CPU has 12 memory DIMM slots. Those DIMMs are organized into 6 different channels so there are 2 DIMMs per channel. For best performance all memory channels should be populated with the same number of DIMMs, either 6 or 12 DIMMs per CPU.

Supported type DIMMs are:

- RDIMMs (Registered DIMM) Provides for higher capacity options and advanced RAS features. It is the most commonly used DIMM type, and offers the best mix of frequency, capacity, and rank structure choices.
- LRDIMMs (Load Reduced DIMM) Provides maximum capacity beyond that of an RDIMM but at a higher power consumption. Uses a buffer to reduce memory loading to a single load on all DDR signals, allowing for greater density.
- NVDIMM (Non-Volatile DIMM) Provides a persistent memory solution with NAND and DRAM that maintains data in power loss, system crash, or normal shutdown. This solution requires a battery as a power source for an AC loss condition. It can be used in conjunction with RDIMMs.
- DCPMM (also known as Intel® Optane[™] DC persistent memory) Provides a large memory capacity at an affordable price. Any application can take advantage of DCPMM in Memory Mode with a compatible operating system. Unlock more performance as well as persistency when using an application that supports App Direct Mode. DCPMM is used in conjunction with RDIMMs or LRDIMMs and a maximum number of 6 DCPMMs can be used per CPU. This persistent memory technology does not require a battery.

Intel® Optane[™] DC Persistent Memory (DCPMM)

Intel® Optane[™] DC Persistent Memory is a new memory technology that allows customers to reach a large memory capacity at an affordable price. Additionally, when operating the memory in "App Direct Mode" the memory is persistent.

DCPMM comes in 3 different memory sizes, 128GB, 256GB, and 512GB.

RDIMMs and LRDIMMs are used in conjunction with Intel® Optane[™] DC persistent memory. Each channel will be populated with up to one DIMM of DRAM and one DIMM of DPCMM. That means that each CPU will have up to 6 DIMMs of DRAM and 6 DIMMs of DCPMM. For best performance it is recommended to have all 12 DIMMs slots per CPU populated.

Intel Optane DC persistent memory operates in two modes, Memory Mode and Application Direct Mode:

Table 6. Operating modes

Trait	Memory mode	App Direct Mode
Application support	Any application	Application must state that it supports "App Direct Mode"
DRAM	Used as cache and is not available as system memory	Both DCPMM and DRAM are available as system memory
Persistence	No	Yes

Supported memory

The table below lists the supported DIMMs for the R740 and R740xd:

Table 7. Supported memory

DIMM Capacity	DIMM Туре	DIMM Speed 1 DPC - 2 DPC	Ranks per DIMM	Data Width
8 GB	RDIMM	2666 MT/s - 2666 MT/s	1	x8
16 GB	RDIMM	2933 MT/s - 2666 MT/s	2	x8

Table 7. Supported memory (continued)

DIMM Capacity	DIMM Туре	DIMM Speed 1 DPC - 2 DPC	Ranks per DIMM	Data Width
32 GB	RDIMM	2933 MT/s - 2666 MT/s	2	x4
64 GB	RDIMM	2933 MT/s - 2666 MT/s	2	x4
128 GB	L RDIMM	2666 MT/s - 2666 MT/s	8	х4
16 GB	NVDIMM-N	2666 MT/s	1	x4
256GB	DCPMM	2666 MT/s	N/A	N/A
512GB	DCPMM	2666 MT/s	N/A	N/A

DIMM speed and frequency

The table below lists the memory speed and frequency for the R740 and R740xd:

Table 8. Memory speed and frequency

CPU Family	DIMM Туре	DIMM Ranking	Capacity	Speed (MT/s)
Intel® Xeon® Scalable	RDIMM	1R/2R	8GB, 16GB, and 32GB	2666
2nd Generation Intel® Xeon® Scalable	RDIMM	1R	8GB	2666
2nd Generation Intel® Xeon® Scalable	RDIMM	2R	16GB, 32GB, and 64Gb	2933
Intel® Xeon® Scalable	LRDIMM	4R/8R	64GB and 128GB	2666
2nd Generation Intel® Xeon® Scalable	LRDIMM	8R	128GB	2666
2nd Generation Intel® Xeon® Scalable	DCPMM	N/A	128GB, 256GB, and 512GB	2666
Intel® Xeon® Scalable or 2nd Generation Intel® Xeon® Scalable	NVDIMM	1R	16GB	2666

Memory operating modes

Performance Optimized or Optimizer Mode: prioritizes performance and does not provide any RAS features beyond standard ECC (Error-Correcting Code).

Memory mirroring has two adjacent memory channels configured to write the same data to each channel. If one memory channel fails or encounters an error, the other channel continues to transmit data. It's an excellent safeguard for systems requiring uninterrupted operation, though it cuts memory capacity in half, can double the cost per gigabyte, and can increase power consumption.

Fault resilient memory is a Dell patented technology that works with the VMWare ESXi Hypervisor to provide a fault resilient zone that protects virtual machines from the ramifications of memory faults.

Memory sparing can reduce downtime from correctable errors by allocating one rank (64-bit wide data area on a DIMM) per channel (Single Rank Spare Mode) or two ranks per channel (Multi Rank Spare Mode) as memory spares. If a correctable error occurs in a rank or channel, it's moved to the spare rank while the OS is running. This prevents the error from causing a failure. Memory sparing reduces memory capacity by one rank per channel or two ranks per channel (depending if Single Rank or Multi Rank is selected) and increases the cost per gigabyte.

Storage

6

The Dell EMC PowerEdge R740 and R740xd provide scalable storage that allows you to adapt to your workload and operational demands. With comprehensive storage options, the R740 and R740xd offer various internal and external storage controllers, drive types and different chassis and backplanes for varied numbers of drives. Features such as NVMes, H740P and H840 RAID controller provide vastly accelerated performance over previous technologies. Dell EMC Express Flash drives use PCIe lanes to connect directly to the processor and chipset and are easily accessible through a hot-plug drive bay.

The PowerEdge R740 offers the storage options below:

- 8 x 2.5 -inch drives in front backplane
- 8 x 3.5 -inch drives in front backplane
- 16 x 2.5 inch drives in front backplane
- No rear or mid-bay storage options

The PowerEdge R740xd expands the available options with new rear and mid-bay storage capabilities. It offers 12×3.5 -inch and 24×2.5 -inch storage options in the front backplane with the following additional options:

- A new 4 x 2.5 -inch rear storage option.
- A new 2 x 3.5 -inch rear storage option.
- The 4 x 3.5 -inch mid-bay storage option, which also supports 2.5 -inch drives in the Hybrid carrier

Topics:

- Supported drives
- Storage controllers
- Optical Drives
- Tape Drives
- IDSDM with vFlash card

Supported drives

The following table shows the list of supported drives by the R740 and R740xd:

Table 9. Supported drives

Form Factor	Туре	Speed	Rotational Speed	Capacities
2.5 -inch	SATA SSD	6Gb	N/A	120GB Boot, 240GB Boot, 240GB, 400GB, 480GB, 800GB, 960GB, 1600GB, 1920GB, 3200GB, 3840GB.
	SATA	6Gb	7.2K	1ТВ, 2ТВ
	SAS	12Gb	7.2K	1TB, 2TB, 2TB(SED FIPS)
	SAS SSD	12Gb	N/A	400GB, 480GB, 800GB, 960GB, 1600GB, 1920GB, 3840GB, 7.68TB
	SAS	12Gb	10K	300GB, 600GB, 768 GB, 1.2TB, 1.8TB, 2.4TB(P- RTS), 1.2TB(SED FIPS), 2.4TB (SED FIPS)(P- RTS)
	SAS	12Gb	15K	300GB, 600GB, 900GB, 900GB (SED FIPS)
3.5 -inch	SATA	6Gb	7.2K	1TB, 2TB, 4TB, 8TB, 10TB, 12TB, 14TB, 16TB
	SAS	12Gb	7.2K	1TB, 2TB, 4TB, 8TB, 10TB, 4TB (SED FIPS), 8TB (SED FIPS)

The following table list the supported NVMe SSD drives:

Table 10. NVMe SSD offerings

Description
NVMe PM1735a 1.6TB GB 2.5" PCIe SSD
NVMe PM1735a 3.2TB GB 2.5" PCIe SSD
NVMe PM1735a 6.4TB GB 2.5" PCIe SSD
NVMe PM1735a 12.8TB GB 2.5" PCIe SSD
NVMe PM1733a 1.92TB GB 2.5" PCIe SSD
NVMe PM1733a 3.8TB GB 2.5" PCIe SSD
NVMe PM1733a 7.6TB GB 2.5" PCIe SSD
NVMe PM1733a 15.36TB GB 2.5" PCIe SSD

Storage controllers

The PowerEdge R740 and R740xd supports the following storage controllers:

- Internal storage controller cards: H330 (R740 only), H350 (R740 only), H730P, H740P, H750, HBA350i, HBA330, S140, and Boot Optimized Storage Subsystem (BOSS) module.
- External storage controller cards: H840, 12Gbps SAS HBA, and HBA355e

Optical Drives

The PowerEdge R740 supports one of the following internal optical drive options:

- DVD-ROM
- DVD+ROM

The R740xd does not support an internal optical drive.

Tape Drives

The R740 and R740xd do not support internal tape drives. However, external tape backup devices will be supported on both R740 and R740xd.

Supported external tape drives:

- External RD1000 USB
- External LTO-5, LTO-6, LTO-7 and 6 Gb SAS tape drives
- 114X rack mount chassis with LTO-5, LTO-6, and LTO-7 6Gb SAS tape drives
- TL1000 with LTO-5, LTO-6, and LTO-7 6 Gb SAS tape drives
- TL2000 with LTO-5, LTO-6, and LTO-7 6 Gb SAS tape drives
- TL4000 with LTO-5, LTO-6, and LTO-7 6 Gb SAS tape drives
- TL4000 with LTO-5, LTO-6, and LTO-7 8Gb FC tape drives
- ML6000 with LTO-5, LTO-6, 6 Gb SAS tape drives
- ML6000 with LTO-5, LTO-6, LTO-7 8Gb FC tape drives
- ML3 with LTO-6, and LTO-7 LTO-8, 6 Gb SAS tape drives

IDSDM with vFlash card

The PowerEdge R540 system supports Internal Dual SD module (IDSDM) and vFlash card. In the current generation of PowerEdge servers, IDSDM and vFlash card are combined into a single card module, and are available in these configurations:

- vFlash or
- IDSDM or

• vFlash and IDSDM

The IDSDM/vFlash card sits in the back of the system, in a Dell-proprietary slot. IDSDM/vFlash card supports three micro SD cards (two cards for IDSDM and one card for vFlash). Micro SD cards capacity for IDSDM is 16/32/64 GB while for vFlash the micro SD card capacity is 16 GB.

Boot Optimized Storage Subsystem (BOSS)

BOSS is a simple RAID solution card that is designed specifically for booting the system's operating system, which supports up to two 6 Gbps M.2 SATA drives. This card has a x8 connector using PCIe gen 2.0 x2 lanes, available only in the low-profile and half-height form factor.

Networking and PCIe

The PowerEdge R740/740xd offers balanced, scalable I/O capabilities, including integrated PCIe 3.0-capable expansion slots. Dell EMC Network Daughter Cards allow you to choose the right network fabric without using up a valuable PCI slot. You can pick the speed, technology, vendor, and other options, such as switch-independent partitioning, which allows you to share and manage bandwidth on 10 GbE connections. For details on the various networking cards available, talk to Dell representative or visit https://www.dell.com/en-us/work/shop/povw/poweredge-r740 or https://www.dell.com/en-us/work/shop/povw/poweredge-r740xd and choose the green view configurations button at the top for a full list of options.

PCIe subsystem

There are a number of riser combinations offered for the R740 and R740xd. Specific riser options are required for certain options like GPU enablement and NVMe PCIe SSD enablement.

The following list the PCIe risers offered for both R740 and R740xd:

(i) NOTE: The R740 and R740xd also offer "no riser" options for customers that do not require any PCIe cards in their system

The below table shows the PCIe expansion card riser configuration for R740 and R740xd:

Expansion card riser	PCIe slots on the riser	Height	Length	Link
Riser 1A	Slot 1	Full Height	Full Length	x16
	Slot 3	Full Height	Half Length	x16
Riser 1B	Slot 1	Full Height	Full Length	×8
	Slot 2	Full Height	Full Length	x8
	Slot 3	Full Height	Half Length	×8
Riser 1D	Slot 1	Full Height	Full Length	x16
	Slot 2	Full Height	Full Length	×8
	Slot 3	Full Height	Half Length	x8
Riser 2A or 2E or 2D or 2F	Slot 4	Full Height	Full Length	x16
	Slot 5	Full Height	Full Length	x8
	Slot 6	Low Profile	Half Length	x8
Riser 2B	Slot 4	Low Profile	Half Length	×8
Riser 2C	Slot 4	Low Profile	Half Length	x16
Riser 3A or 3B	Slot 7	Full Height	Full Length	x8
	Slot 8	Full Height	Full Length	x16

Table 11. PCIe expansion card riser configuration for R740 and R740xd

The below table shows the PCle riser configuration for R740 and R740xd:

Table 12. PCIe riser configuration

Riser configuration	Numbers of CPUs	Supported PERC type	Possible rear storage
No riser	1 or 2	Mini-Mono	Yes
Table 12. PCIe riser configuration (continued)

Riser configuration	Numbers of CPUs	Supported PERC type	Possible rear storage
1B+2B	1 or 2	Mini-Mono / Adapter	Yes
1B+2C	2	Mini-Mono / Adapter	Yes
1A+2A	2	Adapter	No
1A+2A+3A or 1A+2E+3B	2	Adapter	No
1B+2A+3A	2	Mini-Mono / Adapter	No
1D+2A+3A or 1D+2E+3B	2	Adapter	No
1A+2D+3A or 1A+2F+3B	2	Adapter	No

Supported operating system

The following lists the supported operating systems for the PowerEdge R740 and R740xd:

- 1. Canonical® Ubuntu® Server LTS
- 2. Citrix® Hypervisor
- 3. Microsoft® Windows Server® LTSC with Hyper-V
- 4. Red Hat® Enterprise Linux
- **5.** SUSE® Linux Enterprise Server
- 6. VMware® ESXi®

For specifications and interoperability details, see Dell.com/OSsupport.

Power, thermal and acoustics

Topics:

- Power
- Thermal
- Acoustics

Power

Energy Smart power supplies have intelligent features, such as the ability to dynamically optimize efficiency while maintaining availability and redundancy. Also featured are enhanced power- consumption reduction technologies, such as high- efficiency power conversion and advanced thermal- management techniques, and embedded power- management features, including high-accuracy power monitoring.

Table 13. PSU specification

Wattage	Frequency	Voltage	Class	Heat dissipation
495W	50/60Hz	100-240Vac/6.5-3A	Platinum	1908 BTU/hr
750W	50/60Hz	100-240Vac/10-5A	Platinum	2891 BTU/hr
750WT	50/60Hz	200-240Vac/5A	Titanium	2843 BTU/hr
750W Mix Mode/ HVDC(China Only)	50/60Hz	100-240Vac/10-5A	Platinum	2891 BTU/hr
	N/A	240Vdc/4.5A	N/A	
1100W DC	-	-4860Vdc/32A	Gold	4416 BTU/hr
1100W	50/60Hz	100-240Vac/12-6.5A	Platinum	4100 BTU/hr
1100W Mix Mode/	50/60Hz	100-240Vac/12A-6.5A	Platinum	4100 BTU/hr
HVDC(China and Japan Only)	N/A	200-380Vdc/6.4A-3.2A	N/A	4100 BTU/hr
1600W	50/60Hz	100-240Vac/10A	Platinum	6000 BTU/hr
2000W	50/60Hz	100-240Vac/11.5A	Platinum	7500 BTU/hr
2400W	50/60Hz	100-240Vac/16A	Platinum	9000 BTU/hr

Table 14. PSU efficiency

Form factor	Output	Class	10%	20%	50%	100%
Redundant 86mm	495W AC	Platinum	82.00%	90.00%	94.00%	91.00%
	750W AC	Titanium	90.00%	94.00%	96.00%	91.00%
	750W AC	Platinum	82.00%	90.00%	94.00%	91.00%
	750W HVDC	Platinum	82.00%	90.00%	94.00%	91.00%
	1100W AC	Platinum	89.00%	93.00%	94.50%	92.00%
	1100W DC	Gold	80.00%	88.00%	91.00%	88.00%
	1600W AC	Platinum	87.00%	90.00%	94.00%	91.00%
	2000W AC	Platinum	89.00%	93.0 0%	94.00%	91.00%

Table 14. PSU efficiency (continued)

Form factor	Output	Class	10%	20%	50%	100%
	2400W AC	Platinum	89.00%	93.00%	94.00%	91.50%

Thermal

Thermal management of the PowerEdge R740 and R740xd delivers high performance for the right amount of cooling to components at the lowest fan speeds across a wide range of ambient temperatures from 10°C to 35°C (50°F to 95°F) and to extended ambient temperature ranges (see Environmental Specifications). The benefits to you are lower fan power consumption (lower server system power and data center power consumption) and greater acoustical versatility.

() **NOTE:** The recommended ambient temperature for R740 and R740xd is generally 30°C, there are some exceptions for R740xd GPU and NVMe configurations that can be found in the support documentation.

Thermal design

The PowerEdge R740 and R740xd server cooling builds on the features and capability of previous Dell EMC servers but expands support for higher power processors, PCIe cooling, and increased NVMe count. A new chassis mechanical architecture enables increased airflow capability for cooling of higher power and dense system configurations and results in fewer system restrictions and increased feature density. Dell Server Thermal, Mechanical, and Thermal Control designs are based on the following key tenets and order of priority.

The thermal design of the system reflects the following:

- Optimized thermal design: The system layout is architected for optimum thermal design. System component placement and layout are designed to provide maximum airflow coverage to critical components with minimal expense of fan power.
- Comprehensive thermal management: The thermal control system regulates the system fan speeds based on feedback from system component temperature sensors, as well as for system inventory and subsystem power draw. Temperature monitoring includes components such as processors, DIMMs, chipset, system inlet air temperature and hard disk drives.
- Open and closed loop fan speed control: Open loop fan control uses system configuration to determine fan speed based on system inlet air temperature. Closed loop thermal control uses temperature feedback to dynamically adjust fan speeds based on system activity and cooling requirements.
- User-configurable settings: With the understanding and realization that every customer has a unique set of circumstances
 or expectations from the system, in this generation of servers, we have introduced limited user-configurable settings in the
 iDRAC9BIOS setup screen. For more information, see the Dell EMC PowerEdge system Installation and Service Manual on
 Dell.com/Support/Manuals and "Advanced Thermal Control: Optimizing across Environments and Power Goals" on Dell.com.
- Cooling redundancy: The system allows N+1 fan redundancy, allowing continuous operation with one fan failure in the system.

Acoustics

The PowerEdge R740 is quiet enough to be used in an office environment in typical and minimum configurations, and the R740Xd can also operate at a similar level in certain configurations.

Acoustical design

The acoustical design of the PowerEdge R740 and R740xd reflect the following:

- Versatility: The R740 and R740xd save you power draw in the data center but are also quiet enough for office environment in typical and minimum configurations. You may find that the system is sufficiently quiet where the sound it emits blends into the environment.
- Adherence to Dell EMC's high sound quality standards: Sound quality is different from sound power level and sound pressure level in that it describes how humans respond to annoyances in sound, like whistles and hums. One of the sound quality metrics in the Dell EMC specification is prominence ratio of a tone.
- Noise ramp and descent at boot-up from power off: Fan speeds and noise levels ramp during the boot process(from power- off to power-on) in order to add a layer of protection for component cooling in the event that the system were not to boot properly. In order to keep the boot-up process as quiet as possible, the fan speed reached during boot-up is limited to about half of full speed.

- Noise level dependencies: If acoustics is important to you, several configuration choices and settings are important to consider:
 - For lower acoustical output, use a small number of lower rotational- speed SATA hard drives, nearline SAS hard drives, or non- rotational devices like SSDs. 15k hard drives generate more acoustic noise than that of lower rotational- speed hard drives, and noise increases with number of hard drives.
 - Fan speeds and noise may increase from baseline factory configurations if certain profiles are changed by the user or the system configurations are updated.
 - iDRAC9 BIOS settings: Performance Per Watt (DAPC or OS) may be quieter than Performance or Dense Configuration (iDRAC Settings > Thermal > Max. Exhaust Temperature or Fan speed offset).
 - The quantity and type of PCle cards installed: This affects overall system acoustics. Installation of more than two
 PCle cards results in an increase in overall system acoustics.
 - Using a GPU card: This results in an increase in overall system acoustics.
 - PCle controller-based SSD drives: Drives such as Express flash drives and Fusion-IO cards require greater airflow for cooling, and result in significantly higher noise levels.
 - Systems with an H330 PERC: This configuration may be quieter than those with an H730P PERC with battery backup. However, higher noise levels result when a system is configured as non-RAID.
 - Hot spare feature of power supply unit: In the system default setting, the Hot Spare Feature is disabled; acoustical
 output from the power supplies is lowest in this setting.

The following table shows the reference points and output comparisons:

Table 15. Reference points and output comparison

Value measured at your ears		Equivalent familiar noise experience	
LpA, dBA, re 20 µPa	Loudness, sones		
90	80	Loud concert	
75	39	Data center, vacuum cleaner, voice must be elevated to be heard	
60	10	Conversation levels	

Rack rails

The rail offerings for the PowerEdge R740 consist of two general types: sliding and static

Sliding rails features summary

The sliding rails (two varieties are offered) allow the system to be fully extended out of the rack for service. They are available with or without the optional cable management arm (CMA).



Figure 5. Sliding rails with optional CMA

ReadyRails-Sliding rails for 4-post racks

- Supports Drop-in Installation of the chassis to the rails.
- Support for tool-less installation in 19" EIA-310-E compliant square or unthreaded round hole 4-post racks including all generations of the Dell racks.
- Support for tooled installation in 19" EIA-310-E compliant threaded hole 4-post racks.
- Support full extension of the system out of the rack to allow serviceability of key internal components.
- Support for optional cable management arm (CMA).
- Minimum rail mounting depth without the CMA: 714 mm.
- Minimum rail mounting depth with the CMA: 845 mm.
- Square-hole rack adjustment range: 631-868 mm.
- Round-hole rack adjustment range: 617-861 mm.
- Threaded-hole rack adjustment range: 631-883 mm.

Stab-in/Drop-in sliding rails for 4-post racks (New for 14G systems)

- Supports drop-in or stab-in installation of the chassis to the rails.
- Support for tool-less installation in 19" EIA-310-E compliant square, unthreaded round hole racks including all generations of the Dell racks. Also supports tool-less installation in threaded round hole 4-post racks.
- Required for installing R740 in a Dell EMC Titan or Titan-D rack.
- Support full extension of the system out of the rack to allow serviceability of key internal components.
- Support for optional cable management arm (CMA).
- Minimum rail mounting depth without the CMA: 714 mm.

- Minimum rail mounting depth with the CMA: 845 mm.
- Square-hole rack adjustment range: 603-915 mm.
- Round-hole rack adjustment range: 603-915 mm.
- Threaded-hole rack adjustment range: 603-915 mm.

Static rails

The static rails support a wider variety of racks than the sliding rails. However, they do not support serviceability in the rack and are thus not compatible with the CMA.



Figure 6. Static rails

Static rails features summary

Static Rails for 4-post & 2-post Racks:

- Supports Stab-in installation of the chassis to the rails.
- Support tool-less installation in 19" EIA-310-E compliant square or unthreaded round hole 4-post racks including all generations of Dell racks.
- Support tooled installation in 19" EIA-310-E compliant threaded hole 4-post and 2-post racks.
- Minimum rail mounting depth: 622 mm.
- Square-hole rack adjustment range: 608-879 mm.
- Round-hole rack adjustment range: 594-872 mm.
- Threaded-hole rack adjustment range: 608-890 mm.

(i) NOTE: One key factor in selecting the proper rails is identifying the type of rack in which they are installed.

Dell EMC OpenManage systems management

Dell EMC OpenManage Portfolio

Simplifying hardware management through ease of use and automation



Figure 7. Dell EMC OpenManage Portfolio

Dell EMC delivers management solutions that help IT Administrators effectively deploy, update, monitor, and manage IT assets. OpenManage solutions and tools enable you to quickly respond to problems by helping them to manage Dell EMC servers effectively and efficiently; in physical, virtual, local, and remote environments, operating in-band, and out-of-band (agent-free). The OpenManage portfolio includes innovative embedded management tools such as the integrated Dell Remote Access Controller (iDRAC), Chassis Management Controller and Consoles like OpenManage Enterprise, OpenManage Power Manager plug in, and tools like Repository Manager.

Dell EMC has developed comprehensive systems management solutions based on open standards and has integrated with management consoles that can perform advanced management of Dell hardware. Dell EMC has connected or integrated the advanced management capabilities of Dell hardware into offerings from the industry's top systems management vendors and frameworks such as Ansible, thus making Dell EMC platforms easy to deploy, update, monitor, and manage.

The key tools for managing Dell EMC PowerEdge servers are iDRAC and the one-to-many OpenManage Enterprise console. OpenManage Enterprise helps the system administrators in complete lifecycle management of multiple generations of PowerEdge servers. Other tools such as Repository Manager, which enables simple yet comprehensive change management.

OpenManage tools integrate with systems management framework from other vendors such as VMware, Microsoft, Ansible, and ServiceNow. This enables you to use the skills of the IT staff to efficiently manage Dell EMC PowerEdge servers.

Topics:

- Server and Chassis Managers
- Dell EMC consoles
- Automation Enablers
- Integration with third-party consoles
- Connections for third-party consoles
- Dell EMC Update Utilities
- Dell resources

Server and Chassis Managers

- Integrated Dell Remote Access Controller (iDRAC)
- iDRAC Service Module (iSM)

Dell EMC consoles

- Dell EMC OpenManage Enterprise
- Dell EMC Repository Manager (DRM)
- Dell EMC OpenManage Enterprise Power Manager plugin to OpenManage Enterprise
- Dell EMC OpenManage Mobile (OMM)

Automation Enablers

- OpenManage Ansible Modules
- iDRAC RESTful APIs (Redfish)
- Standards-based APIs (Python, PowerShell)
- RACADM Command Line Interface (CLI)
- GitHub Scripting Libraries

Integration with third-party consoles

- Dell EMC OpenManage Integrations with Microsoft System Center
- Dell EMC OpenManage Integration for VMware vCenter (OMIVV)
- Dell EMC OpenManage Ansible Modules
- Dell EMC OpenManage Integration with ServiceNow

Connections for third-party consoles

- Micro Focus and other HPE tools
- OpenManage Connection for IBM Tivoli
- OpenManage Plug-in for Nagios Core and XI

Dell EMC Update Utilities

- Dell System Update (DSU)
- Dell EMC Repository Manager (DRM)
- Dell EMC Update Packages (DUP)
- Dell EMC Server Update Utility (SUU)
- Dell EMC Platform Specific Bootable ISO (PSBI)

Dell resources

For additional information about white papers, videos, blogs, forums, technical material, tools, usage examples, and other information, go to the OpenManage page at https://www.dell.com/openmanagemanuals or the following product pages:

Table 16. Dell resources

Resource	Location
Integrated Dell Remote Access Controller (iDRAC)	https://www.dell.com/idracmanuals
iDRAC Service Module (iSM)	https://www.dell.com/support/kbdoc/000178050/
OpenManage Ansible Modules	https://www.dell.com/support/kbdoc/000177308/
OpenManage Essentials (OME)	https://www.dell.com/support/kbdoc/000175879/
OpenManage Mobile (OMM)	https://www.dell.com/support/kbdoc/000176046
OpenManage Integration for VMware vCenter (OMIVV)	https://www.dell.com/support/kbdoc/000176981/
OpenManage Integration for Microsoft System Center (OMIMSSC)	https://www.dell.com/support/kbdoc/000147399
Dell EMC Repository Manager (DRM)	https://www.dell.com/support/kbdoc/000177083
Dell EMC System Update (DSU)	https://www.dell.com/support/kbdoc/000130590
Dell EMC Platform Specific Bootable ISO (PSBI)	Dell.com/support/article/sln296511
Dell EMC Chassis Management Controller (CMC)	www.dell.com/support/article/sln311283
OpenManage Connections for Partner Consoles	https://www.dell.com/support/kbdoc/000146912
OpenManage Enterprise Power Manager	https://www.dell.com/support/kbdoc/000176254
OpenManage Integration with ServiceNow (OMISNOW)	Dell.com/support/article/sln317784

(i) NOTE: Features may vary by server. Please refer to the product page on https://www.dell.com/manuals for details.

Appendix A. Additional specifications

The following sections contain information about additional system specifications.

Topics:

- Chassis dimensions
- Chassis weight
- Video
- USB peripherals
- Environmental specifications

Chassis dimensions



Figure 8. Chassis Dimensions for R740 and R740xd

The following table describes the chassis dimensions:

Table 17. Chassis dimensions

	Chassis dimensions (cm)						
Xa Xb Y Za bezel Za without bezel Zb Za						Zc	
482.0 mm 434.0 mm 86.8 mm 35.84mm 22.0 mm 678.8 mm 715.5 m						715.5 mm	

Chassis weight

This section describes the weight of the system.

Table 18. Chassis weight

Configuration	Maximum Weight
2.5-inch HDD for R740	26.3Kg (57.98 lb)
3.5-inch HDD for R740	28.6Kg (63.05 lb)
2.5-inch HDD for R740xd	28.1Kg (61.95 lb)
3.5-inch HDD for R740xd	33.1Kg (72.91 lb)

Video

The PowerEdge R740 system supports the Matrox G200eW3 graphics module. The following table shows the video specifications:

Table 19. Video specifications

Resolution	Refresh rate	Horizontal frequency	Pixel clock	Rear panel	Front panel
1024 x 768	60 Hz	48.4 kHz	65.0 MHz	Yes	Yes
1280 x 800	60 Hz	49.7 kHz	83.5 MHz	Yes	Yes
1280 x 1024	60 Hz	64.0 kHz	108.0 MHz	Yes	TBD
1360 x 768	60 Hz	47.71 kHz	85.5 MHz	Yes	Yes
1440 × 900	60 Hz	55.9 kHz	106.5 MHz	Yes	TBD
1600 × 900	60 Hz (RB)	55.54 kHz	97.75 MHz	Yes	Yes
1600 x 1200	60 Hz	75.0 kHz	162.0 MHz	TBD	TBD
1680 × 1050	60 Hz (RB)	64.7 kHz	119.0 MHz	Yes	TBD
1920 × 1080	60 Hz	67.158 kHz	173.0 MHz	TBD	No
1920 x 1200	60 Hz	74.556 kHz	193.25 MHz	TBD	No

USB peripherals

Front, rear, and internal USB ports are included in the base system for R740 and R740xd. Rear and internal ports support up to USB 3.0, while front ports support USB 2.0. The R740 offers an upsell option that adds an additional USB 3.0 port to the front of the chassis. The USB upsell module cable connects to the internal USB port on the planar and the default internal moves closer to the front of the chassis

Environmental specifications

See Dell EMC PowerEdge R740 and R740xd installation service manuals at Dell.com/Support/Manuals for detailed environmental specifications.

Appendix B. Standards compliance

Table 20. Industry standard documents

Standard	URL for information and specifications
ACPI Advance Configuration and Power Interface Specification, v2.0c	https://uefi.org/specsandtesttools
Ethernet IEEE 802.3-2005	https://standards.ieee.org/
HDG Hardware Design Guide Version 3.0 for Microsoft Windows Server	microsoft.com/whdc/system/platform/pcdesign/desguide/ serverdg.mspx
IPMI Intelligent Platform Management Interface, v2.0	intel.com/design/servers/ipmi
DDR4 Memory DDR4 SDRAM Specification	jedec.org/standards-documents/docs/jesd79-4.pdf
PCI Express PCI Express Base Specification Rev. 2.0 and 3.0	pcisig.com/specifications/pciexpress
PMBus Power System Management Protocol Specification, v1.2	http://pmbus.org/Assets/PDFS/Public/ PMBus_Specification_Part_I_Rev_1-1_20070205.pdf
SAS Serial Attached SCSI, v1.1	http://www.t10.org/
SATA Serial ATA Rev. 2.6; SATA II, SATA 1.0a Extensions, Rev. 1.2	sata-io.org
SMBIOS System Management BIOS Reference Specification, v2.7	dmtf.org/standards/smbios
TPM Trusted Platform Module Specification, v1.2 and v2.0	trustedcomputinggroup.org
UEFI Unified Extensible Firmware Interface Specification, v2.1	uefi.org/specifications
USB Universal Serial Bus Specification, Rev. 2.0	usb.org/developers/docs

Appendix C Additional resources

Table 21. Additional resources

Resource	Description of contents	Location
PowerEdge R740/R740xd Installation Service Manuals	This manual, available in PDF format, provides the following information:	Dell.com/Support/Manuals
	 Chassis features System Setup program System messages System codes and indicators System BIOS Remove and replace procedures Troubleshooting Diagnostics Jumpers and connectors 	
PowerEdge R740/R740xd Getting Started Guide	 This guide ships with the system, and is also available in PDF format. This guide provides the following information: Initial setup steps Key system features Technical specifications 	Dell.com/Support/Manuals
Rack Installation Instructions	This document ships with the rack kits, and provides instructions for installing a server in a rack.	Dell.com/Support/Manuals
Information Update	This document ships with the system, is also available in PDF format online, and provides information on system updates.	Dell.com/Support/Manuals
System Information Label	The system information label documents the system board layout and system jumper settings. Text is minimized due to space limitations and translation considerations. The label size is standardized across platforms.	Inside the system chassis cover
Quick Resource Locator (QRL)	This code on the chassis can be scanned by a phone application to access additional information and resources for the server, including videos, reference materials, service tag information, and Dell contact information.	Inside the system chassis cover
Energy Smart Solution Advisor (ESSA)	The Dell online ESSA enables easier and more meaningful estimates to help you determine the most efficient configuration possible. Use ESSA to calculate the power consumption of your hardware, power infrastructure, and storage.	Dell.com/calc

Appendix D. Support and deployment services

Topics:

- Dell EMC ProDeploy Enterprise Suite
- Deployment services
- Dell EMC Remote Consulting Services
- Dell EMC Data Migration Service
- ProSupport Enterprise Suite
- ProSupport Plus
- ProSupport
- ProSupport One for Data Center
- Support Technologies
- Additional professional services
- Dell Education Services
- Dell EMC Global Infrastructure Consulting Services
- Dell EMC Managed Services

Dell EMC ProDeploy Enterprise Suite

ProDeploy Enterprise Suite gets your server out of the box and into optimized production—fast. Our elite deployment engineers with broad and deep experience utilizing best-in-class processes along with our established global scale can help you around the clock and around the globe. From simple to the most complex server installations and software integration, we take the guess work and risk out of deploying your new server technology.

		Basic Deployment	ProDeploy	ProDeploy Plus
	Single point of contact for project management	-	•	In-region
Pre-	Site readiness review	-	•	•
deployment	Implementation planning	-	•	•
	SAM engagement for ProSupport Plus entitled devices	-	-	•
	Deployment service hours	Business hours	24x7	24x7
Depleyment	Remote guidance for hardware installation or Onsite hardware installation and packaging material removal	Onsite	Remote or Onsite	Onsite
Deployment	Install and configure system software	-	Remote	Onsite
	Install support software and connect with Dell Technologies	-	•	•
	Project documentation with knowledge transfer	-	•	•
	Deployment verification	-		•
Post-	Configuration data transfer to Dell EMC technical support	-	•	•
deployment	30-days of post-deployment configuration assistance	-	-	•
	Training credits for Dell EMC Education Services	-	-	•

Figure 9. ProDeploy Enterprise Suite capabilities

(i) NOTE: Hardware installation not applicable on selected software products.

Dell EMC ProDeploy Plus

From beginning to end, ProDeploy Plus provides the skill and scale needed to successfully execute demanding deployments in today's complex IT environments. Certified Dell EMC experts start with extensive environmental assessments and detailed migration planning and recommendations. Software installation includes set up of most versions of Dell EMC SupportAssist and OpenManage system management utilities. Post-deployment configuration assistance, testing, and product orientation services are also available.

Dell EMC ProDeploy

ProDeploy provides full service installation and configuration of both server hardware and system software by certified deployment engineers including set up of leading operating systems and hypervisors as well as most versions of Dell EMC SupportAssist and OpenManage system management utilities. To prepare for the deployment, we conduct a site readiness review and implementation planning exercise. System testing, validation, and full project documentation with knowledge transfer complete the process.

Dell EMC Basic Deployment

Basic Deployment delivers worry-free professional installation by experienced technicians who know Dell EMC servers inside and out.

Dell EMC Residency Services

Residency Services helps customers transition to new capabilities quickly with the assistance of on-site or remote Dell EMC experts whose priorities and time you control. Residency experts can provide post implementation management and knowledge transfer related to a new technology acquisition or day-to-day operational management of the IT infrastructure.

Deployment services

Deployment services details and exceptions can be found in service description documents at the Enterprise Configuration and Deployment pageon Dell.com.

Dell EMC Remote Consulting Services

When you are in the final stages of your PowerEdge server implementation, you can rely on Dell EMC Remote Consulting Services and our certified technical experts to help you optimize your configuration with best practices for your software, virtualization, server, storage, networking, and systems management.

Dell EMC Data Migration Service

Protect your business and data with our single point of contact to manage your data migration project. Your project manager will work with our experienced team of experts to create a plan using industry-leading tools and proven processes based on global best practices to migrate your existing files and data so your business system get up and running quickly and smoothly.

ProSupport Enterprise Suite

With the ProSupport Enterprise Suite, we can help you keep your operation running smoothly, so you can focus on running your business. We will help you maintain peak performance and availability of your most essential workloads. ProSupport Enterprise Suite is a suite of support services that enable you to build the solution that is right for your organization. Choose support models based on how you use technology and where you want to allocate resources. From the desktop to the data center, address everyday IT challenges, such as unplanned downtime, mission-critical needs, data and asset protection, support

planning, resource allocation, software application management and more. Optimize your IT resources by choosing the right support model.

ProSupport Plus for Enterprise	Proactive, predictive and reactive support for systems that look after your business-critical applications and workloads	
ProSupport for Enterprise	Comprehensive 24x7 predictive and reactive support for hardware and software	ProSupport Enterprise Suite
Basic hardware support	Reactive hardware support during normal business hours	

Figure 10. ProSupport Enterprise Suite

ProSupport Plus

When you purchase PowerEdge servers, we recommend ProSupport Plus, our proactive and preventative support, for businesscritical systems. ProSupport Plus provides all the benefits of ProSupport, plus the following:

- An assigned Services Account Manager (SAM) who knows your business and your environment
- Access to senior ProSupport engineers for faster issue resolution
- Personalized, preventive recommendations based on analysis of support trends and best practices from across the Dell EMC customer base to reduce support issues and improve performance
- Predictive analysis for issue prevention and optimization enabled by SupportAssist
- Proactive monitoring, issue detection, notification and automated case creation for accelerated issue resolution enabled by SupportAssist
- On-demand reporting and analytics-based recommendations enabled by SupportAssist and TechDirect

ProSupport

Our ProSupport service offers highly trained experts around the clock and around the globe to address your IT needs. We will help you minimize disruptions and maximize availability of your PowerEdge server workloads with:

- 24x7x365 access to certified hardware and software experts
- Collaborative 3rd party support
- Hypervisor and OS support
- Consistent level of support available for Dell EMC hardware, software and solutions
- Onsite parts and labor response options including next business day or four-hour mission critical

ProSupport One for Data Center

ProSupport One for Data Center offers flexible site-wide support for large and distributed data centers with more than 1,000 assets. This offering is built on standard ProSupport components that leverage our global scale but are tailored to your company's needs. While not for everyone, it offers a truly unique solution for Dell EMC's largest customers with the most complex environments.

- Team of assigned Services Account Managers (SAM) with remote, on-site options
- Assigned ProSupport One technical and field engineers who are trained on your environment and configurations
- On-demand reporting and analytics-based recommendations enabled by SupportAssist and TechDirect
- Flexible on-site support and parts options that fit your operational model
- A tailored support plan and training for your operations staff

	ProSupport	ProSupport Plus	ProSupport One for Data Center	
Remote technical support	24x7	24x7	24x7	
Parts and labor response options	Next business day or Mission Critical	Next business day or Mission Critical	Flexible	
Automated issue detection and case creation		•	•	
Self-service case initiation and management		•	\bullet	
Hypervisor and OS support.			•	
Priority access to specialized support experts			•	
Designated Technology Service Manager		•	•	
Personalized assessments and recommendations		•		
On-demand support and utilization reports		•	•	
Systems Maintenance guidance		Semiannual	Optional	
Designated technical and field support teams				

Figure 11. Enterprise Support feature comparison

Support Technologies

Powering your support experience with predictive, data-driven technologies.

SupportAssist

The best time to solve a problem is before it happens. The automated proactive and predictive technology SupportAssist* helps reduce steps and time to resolution, often detecting issues before they become a crisis. Benefits include:

- Value SupportAssist is available to all customers at no additional charge.
- Improve productivity replace manual, high-effort routines with automated support.
- Accelerate time to resolution receive issue alerts, automatic case creation and proactive contact from Dell EMC experts.
- Gain insight and control optimize enterprise devices with on-demand ProSupport Plus reporting in TechDirect and get predictive issue detection before the problem starts.

SupportAssist is included with all support plans but features vary based on service level agreement.

	Basic Hardware Warranty	ProSupport	ProSupport Plus
Automated issue detection and system state information collection	•	•	•
Proactive, automated case creation and notification		•	•
Predictive issue detection for failure prevention			•
Recommendation reporting available on-demand in TechDirect			•

Figure 12. SupportAssist model

Get started at Dell.com/SupportAssist

TechDirect

Boost your IT teams productivity when supporting Dell EMC systems. With over 1.4 million self-dispatches processed each year, TechDirect has proven its effectiveness as a support tool. You can:

- Self-dispatch replacement parts
- Request technical support
- Integrate APIs into your help desk

Or, access all your Dell EMC certification and authorization needs. Train your staff on Dell EMC products as TechDirect allows you to:

- Download study guides
- Schedule certification and authorization exams
- View transcripts of completed courses and exams

Register at techdirect.dell.com

Additional professional services

Dell Education Services

Dell Education Services offers the PowerEdge server training courses designed to help you achieve more with your hardware investment. The curriculum is designed in conjunction with the server development team, as well as Dell EMC's technical support team, to ensure that the training delivers the information and practical, hands-on skills you and your team need to confidently manage and maintain your Dell EMC server solution. To learn more or register for a class today, visit LearnDell.com/ Server.

Dell EMC Global Infrastructure Consulting Services

Dell EMC Global Infrastructure Consulting Services use skilled solution architects, innovative tools, automated analysis and Dell EMC's intellectual property to give rapid insight into the root causes of unnecessary complexity. We seek better answers than traditional service models, and our strategy is to help quickly identify high-impact, short-duration projects that deliver return on investment (ROI) and free up resources. The results are practical, action-oriented plans with specific, predictable, measurable outcomes. From data center optimization to server virtualization to systems management, our consulting services can help build a more efficient enterprise.

Dell EMC Managed Services

Dell EMC Managed Services are a modular set of lifecycle services designed to help you automate and centrally configure, deploy, and manage your day-to-day data center operations. These services extend your existing on-premise IT infrastructure with off-premise cloud services designed to better address challenges with mobility, highly distributed organizations, security, compliance, business continuity, and disaster preparedness.